80V N-Channel Trench Power MOSFET

General Description

The SJJ80N075 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

Features

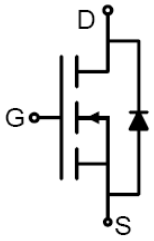
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

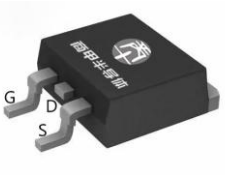
- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	80	V
$R_{DS(ON)\_TYP}$	7.3	mΩ
I_D	81	A
Q_G	97	nC



Schematic Diagram



TO-263 top view

RoHS

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJJ80N075	SJJ80N075	TO-263	Tape	\	\	1000 Pcs

Table 1. Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage (V_{GS}=0V)	80	V
V_{GS}	Gate-Source Voltage (V_{DS}=0V)	±20	V
I_D	Drain Current-Continuous(T_C=25℃)	81	A
	Drain Current-Continuous(T_C=100℃)	51	A
$I_{DM\ (pluse)}$	Drain Current-Continuous@ Current-Pulsed (Note 1)	324	A
P_D	Maximum Power Dissipation(T_C=25℃)	125	W
	Maximum Power Dissipation(T_C=100℃)	50	W
E_{AS}	Avalanche energy (Note 2)	361	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	℃

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to- Case		1.0	℃/W

Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V I_D=250μA	80			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=80V, V_{GS}=0V			1	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±20V, V_{DS}=0V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250μA	2		4	V
g_{FS}	Forward Transconductance	V_{DS}=10V, I_D=15A		15		S
$R_{DS(ON)}$	Drain-Source On-State Resistance	V_{GS}=10V, I_D=40A		7.3	8.7	mΩ
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS}=25V,V_{GS}=0V, f=1.0MHz		4162		pF
C_{oss}	Output Capacitance			247		pF
C_{rss}	Reverse Transfer Capacitance			183		pF
Rg	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1.0MHz		0.57		Ω
Switching Parameters						
$t_{d(on)}$	Turn-on Delay Time	V_{GS}=10V, V_{DS}=40V, R_L=1Ω, R_{GEN}=3Ω		27		nS
t_r	Turn-on Rise Time			20		nS
$t_{d(off)}$	Turn-Off Delay Time			58		nS
t_f	Turn-Off Fall Time			24		nS
Q_g	Total Gate Charge	V_{GS}=10V, V_{DS}=40V, I_D=40A		97		nC
Q_{gs}	Gate-Source Charge			18.5		nC
Q_{gd}	Gate-Drain Charge			38		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				81	A
V_{SD}	Forward on Voltage (Note 3)	V_{GS}=0V, I_S=40A			1.2	V
t_{rr}	Reverse Recovery Time	I_F=20A, dI/dt=500A/μs		40		ns
Q_{rr}	Reverse Recovery Charge	I_F=20A, dI/dt=500A/μs		59		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.
Notes 2.E_{AS} condition: T_J=25℃,V_{DD}=40V,V_G=10V, Rg=25Ω, L=0.5mH.
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

Typical Electrical And Thermal Characteristics (Curves)

Figure 1. Output Characteristics

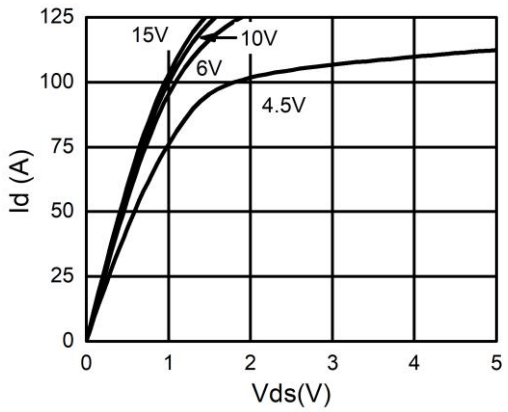


Figure 2. Transfer Characteristics

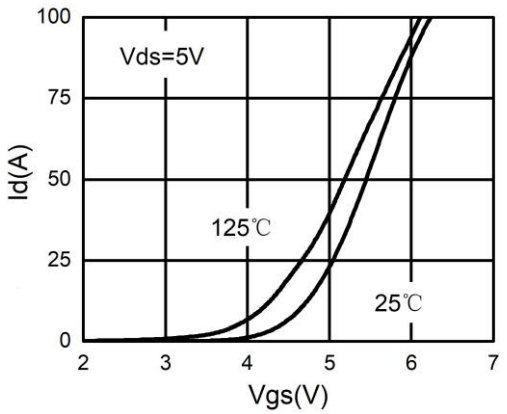


Figure 3. Power Dissipation

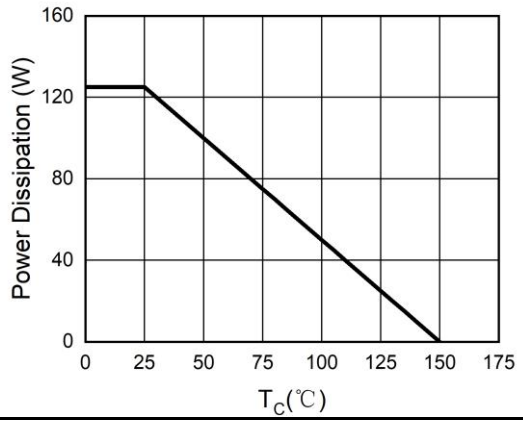


Figure 4. Drain Current

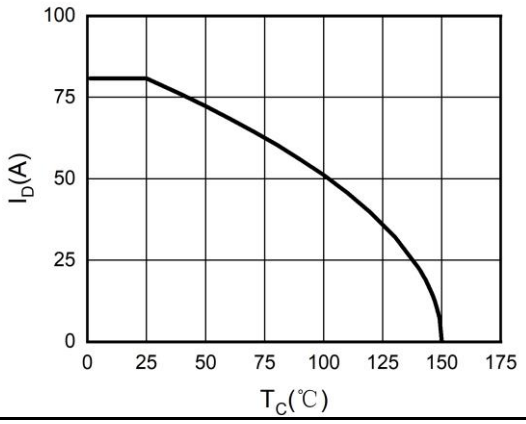


Figure 5. BV_{DSS} vs Junction Temperature

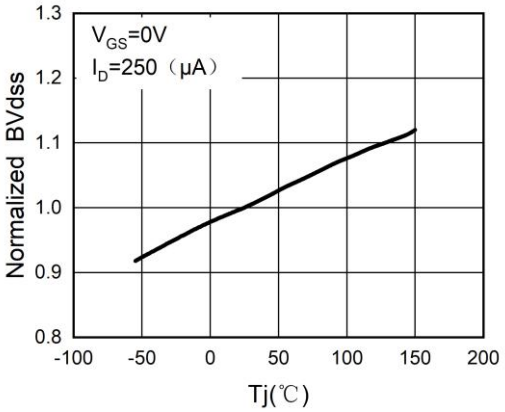
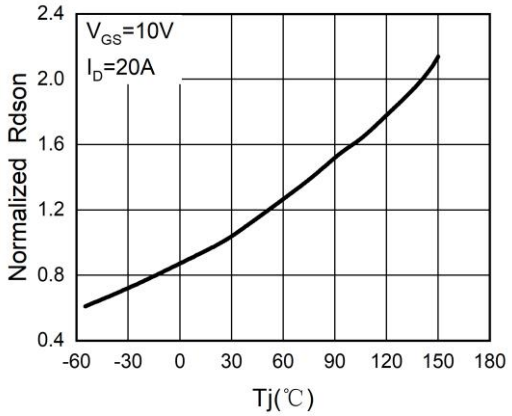


Figure 6. $R_{DS(ON)}$ vs Junction Temperature



Typical Electrical And Thermal Characteristics (Curves)

Figure 7. Gate Charge Waveforms

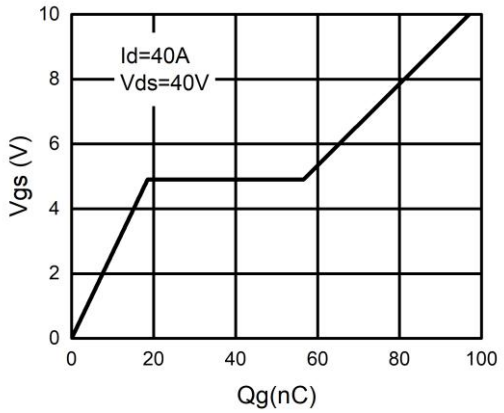


Figure 8. Capacitance

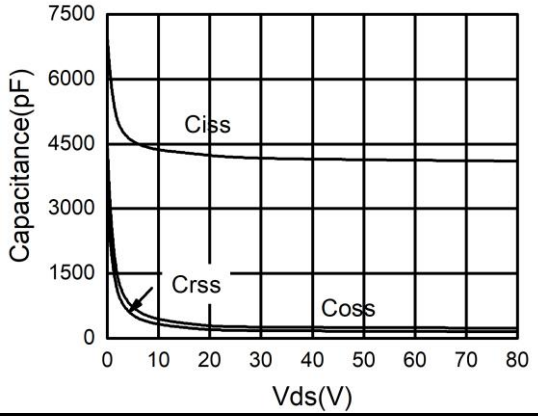


Figure 9. Body-Diode Characteristics

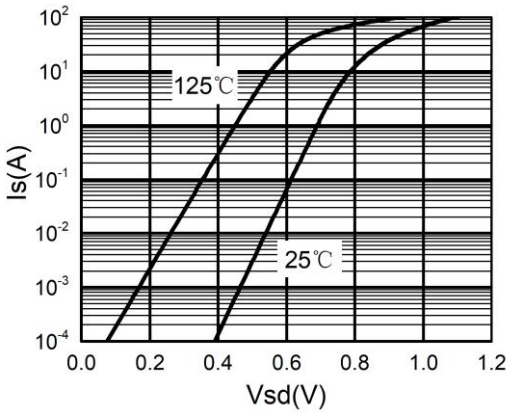
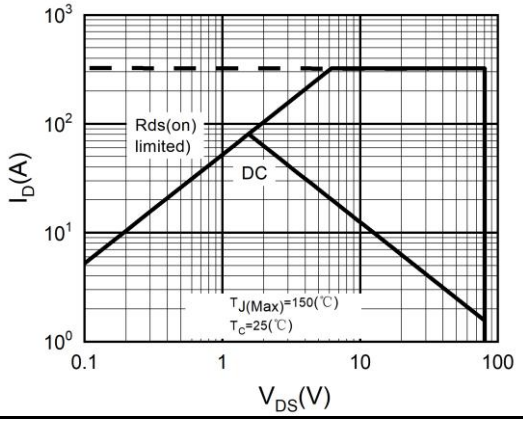
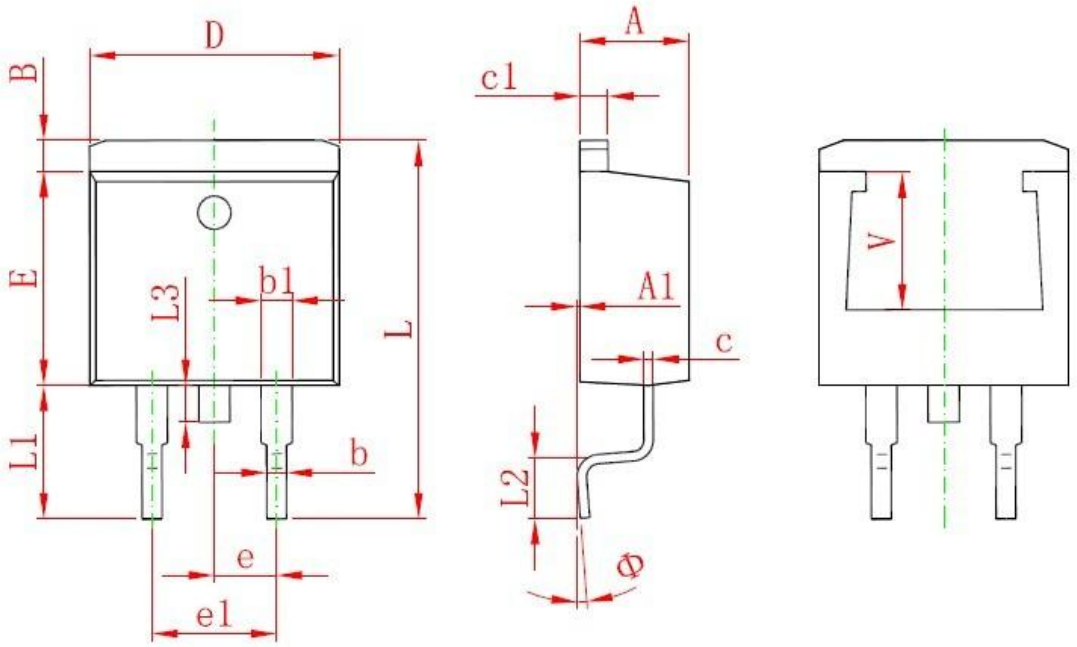


Figure 10. Maximum Safe Operating Area



TO-263 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.120	1.420	0.044	0.056
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100TYP.	
e1	4.980	5.180	0.196	0.204
L	14.940	15.500	0.588	0.610
L1	4.950	5.450	0.195	0.215
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
V	5.600 REF.		0.220REF.	
Φ	0°	8°	0°	8°

Attention

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